Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info: <u>ti.com/support</u>

Form/Declaration Type: Distribute - RoHS and IEC 62474 DB

Created on: **08/27/2022**

Details for "SN74ALS174N"

Current Product Information

	TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
ĺ	SN74ALS174N	NIPDAU	Level-NC-NC-NC	TI AGUASCALIENTES	N 16	6.35x19.3x4.57	1325.4

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS		REACH	Green	IEC 62474 DB	
	Yes	Yes	Yes	Yes	

Component Information

				Homoge	neous Material Level	Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire	·			,			
Copper and Its Alloys	Copper	7440-50-8	0.098147	99.998981	999990	0.007405	74
Precious Metals	Silver	7440-22-4	0.000001	0.001019	10	0	0
Sub-Total			0.098148	100	1000000	0.007405	74
Die Attach Adhesive	'						
Precious Metals	Silver	7440-22-4	0.164722	78.999947	789999	0.012428	124
Thermoplastics	Ероху	85954-11-6	0.043787	21.000053	210001	0.003304	33
Sub-Total			0.208509	100	1000000	0.015731	157
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	410.492385	97.05	970500	30.970257	309703
Copper and Its Alloys	Iron	7439-89-6	10.99722	2.6	26000	0.829703	8297
Copper and Its Alloys	Phosphorus	7723-14-0	0.634455	0.15	1500	0.047867	479
Zinc and Its Alloys	Zinc	7440-66-6	0.84594	0.2	2000	0.063823	638
Sub-Total			422.97	100	1000000	31.911651	319117
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	1.399215	95.119986	951200	0.105566	1056
Precious Metals	Gold	7440-57-5	0.011474	0.780014	7800	0.000866	9
Precious Metals	Palladium	7440-05-3	0.060311	4.1	41000	0.00455	46
Sub-Total			1.471	100	1000000	0.110982	1110
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	791.942598	88	880000	59.749381	597494
Other Plastics and Rubber	Carbon Black	1333-86-4	2.699804	0.3	3000	0.203691	2037
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	4.949641	0.55	5500	0.373434	3734
Thermoplastics	Ероху	85954-11-6	100.342727	11.15	111500	7.570518	75705
Sub-Total			899.93477	100	1000000	67.897024	678970
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.758246	100	1000000	0.057207	572
Sub-Total			0.758246	100	1000000	0.057207	572
Total			1325.440673			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The name calculations are at the component level and are average concentration values. The amount (mg) calculations represent the

The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 08/27/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.